

SANYO Semiconductors DATA SHEET

An ON Semiconductor Company

2SK3703— R-Channel Silicon MOSFET General-Purpose Switching Device Applications

Features

- · Low ON-resistance.
- · 4V drive.
- · Ultrahigh-speed switching.
- · Motor drive, DC / DC converter.
- · Avalanche resistance guarantee.

Specifications

Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
Drain-to-Source Voltage	VDSS		60	V
Gate-to-Source Voltage	VGSS		±20	V
Drain Current (DC)	ID		30	Α
Drain Current (Pulse)	IDP	PW≤10μs, duty cycle≤1%	120	Α
Allowable Power Dissipation	D-		2.0	W
	PD	Tc=25°C	25	W
Channel Temperature	Tch		150	°C
Storage Temperature	Tstg		-55 to +150	°C
Avalanche Energy (Single Pulse) *1	EAS		135	mJ
Avalanche Current *2	IAV		30	Α

Note: *1 V_{DD}=20V, L=200μH, I_{AV}=30A

Electrical Characteristics at Ta=25°C

Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	Oill
Drain-to-Source Breakdown Voltage	V(BR)DSS	ID=1mA, VGS=0V	60			٧
Zero-Gate Voltage Drain Current	IDSS	V _{DS} =60V, V _{GS} =0V			1	μΑ
Gate-to-Source Leakage Current	IGSS	VGS= ±16V, VDS=0V			±10	μΑ
Cutoff Voltage	VGS(off)	V _{DS} =10V, I _D =1mA	1.2		2.6	V
Forward Transfer Admittance	yfs	V _{DS} =10V, I _D =15A	13	22		S
Static Drain-to-Source On-State Resistance	RDS(on)1	ID=15A, VGS=10V		20	26	mΩ
	R _{DS} (on)2	I _D =15A, V _{GS} =4V		28	40	mΩ

Marking: K3703 Continued on next page.

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^{*2} L≤200µH, Single pulse

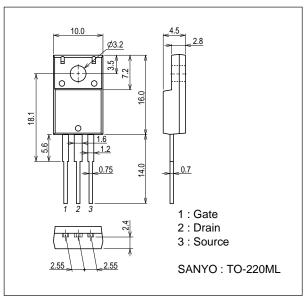
2SK3703

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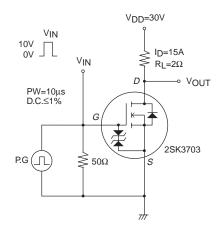
Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	Offic
Input Capacitance	Ciss	V _{DS} =20V, f=1MHz		1780		pF
Output Capacitance	Coss	V _{DS} =20V, f=1MHz		266		pF
Reverse Transfer Capacitance	Crss	V _{DS} =20V, f=1MHz		197		pF
Turn-ON Delay Time	t _d (on)	See specified Test Circuit.		16.5		ns
Rise Time	t _r	See specified Test Circuit.		110		ns
Turn-OFF Delay Time	t _d (off)	See specified Test Circuit.		166		ns
Fall Time	tf	See specified Test Circuit.		144		ns
Total Gate Charge	Qg	V _{DS} =30V, V _{GS} =10V, I _D =30A		40		nC
Gate-to-Source Charge	Qgs	V _{DS} =30V, V _{GS} =10V, I _D =30A		6.5		nC
Gate-to-Drain "Miller" Charge	Qgd	V _{DS} =30V, V _{GS} =10V, I _D =30A		11.5		nC
Diode Forward Voltage	V _{SD}	I _S =30A, V _{GS} =0V		1.0	1.2	V

Package Dimensions

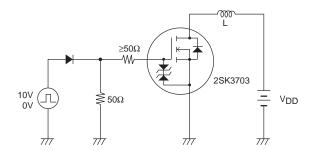
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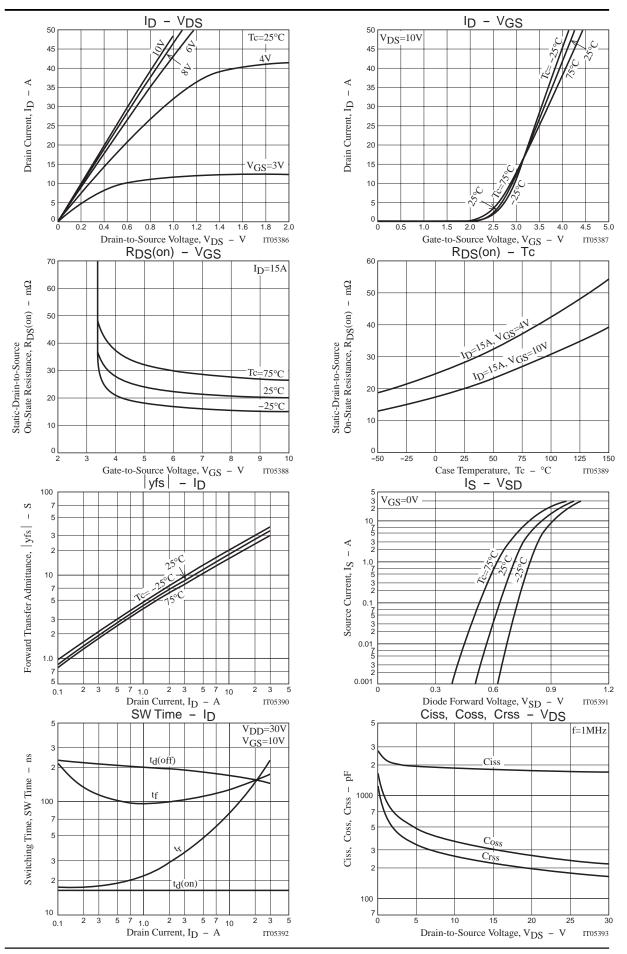


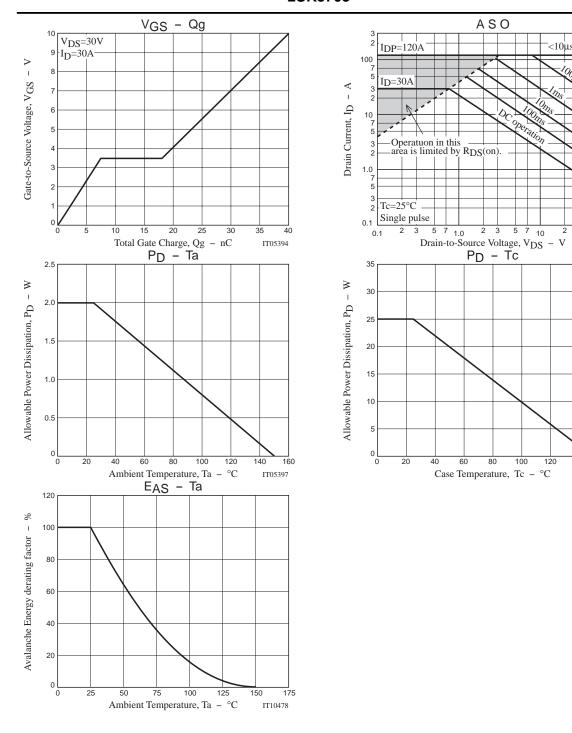
Switching Time Test Circuit



Avalanche Resistance Test Circuit







IT05396

Note on usage: Since the 2SK3703 is a MOSFET product, please avoid using this device in the vicinity of highly charged objects.

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